imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Technical Data Sheet

1.9mm Round Subminiature Axial Infrared LED

Features

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector
- Pb free

IR91-21C

Descriptions

IR91-21C is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor.

Applications

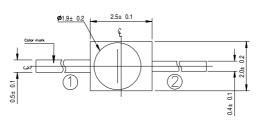
- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

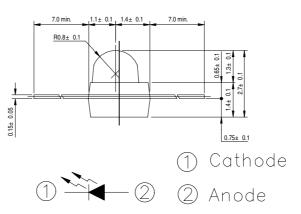
Device Selection Guide

LED Dout No	Chip	Lang Calar	
LED Part No.	Material	Lens Color	
IR	GaAlAs	Water Clear	



Package Dimensions





Notes: 1.All dimensions are in millimeters

2.Tolerances unless dimensions ± 0.1 mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_{\rm F}$	65	mA
Peak Forward Current	I _{FP}	1.0	А
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	°C
Soldering Temperature	T_{sol}	260	°C
Power Dissipation at(or below)	P _d	130	mW
25°C Free Air Temperature			

Notes: *1:I_{FP} Conditions--Pulse Width \leq 100 μ s and Duty \leq 1%.

*2:Soldering time \leq 5 seconds.



<u>IR91-21C</u>

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units	
		I _F =20mA	3.0	5.0			
Radiant Intensity	Ee	$I_F \!\!=\! 100 mA$ Pulse Width $\! \leq \! 100\mu s$,Duty $\! \leq \! 1\%$		25		mW /sr	
Peak Wavelength	λp	I _F =20mA		940		nm	
Spectral Bandwidth	Δλ	I _F =20mA		45		nm	
		I _F =20mA		1.2	1.5		
Forward Voltage	$V_{\rm F}$	$I_F = 100 mA$ Pulse Width $\leq 100 \ \mu \text{ s}$,Duty $\leq 1\%$		1.4	1.8	V	
		I _F =1A	-	2.6	4.0		
Reverse Current	I _R	V _R =5V			10	μA	
View Angle	2 0 1/2	I _F =20mA		25		deg	

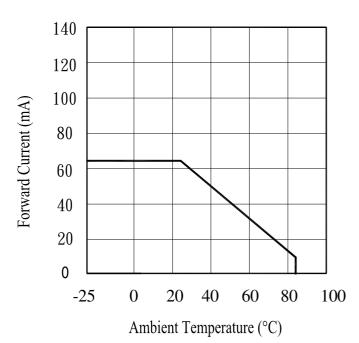


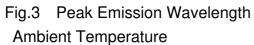
Typical Electro-Optical Characteristics Curves

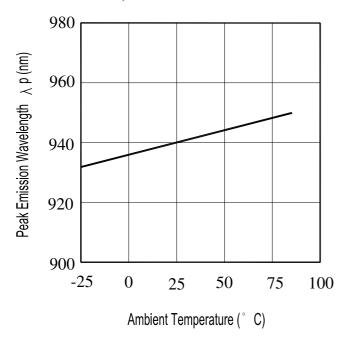
Fig.1 Forward Current vs.

Fig.2 Spectral Distribution

Ambient Temperature







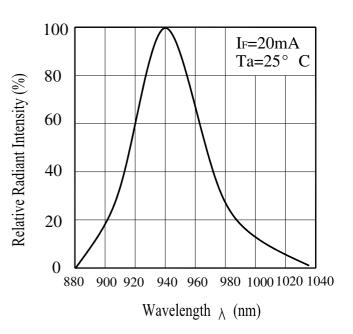
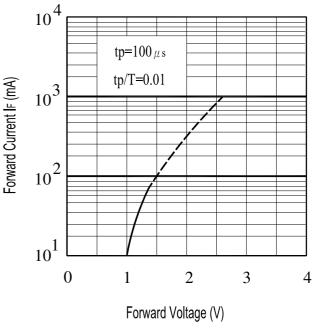


Fig.4 Forward Current vs. Forward Voltage



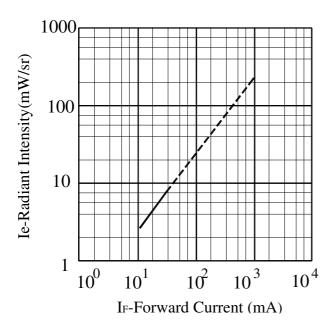
Everlight Electronics Co., Ltd. Device No : DIR-091-027 http://www.everlight.com Prepared date : 07-19-2004 Rev 2.3 Page: 4 of 9 Prepared by : Jaine Tsai

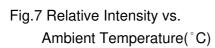


Typical Electro-Optical Characteristics Curves

Fig.5 Relative Intensity vs.

Forward Current





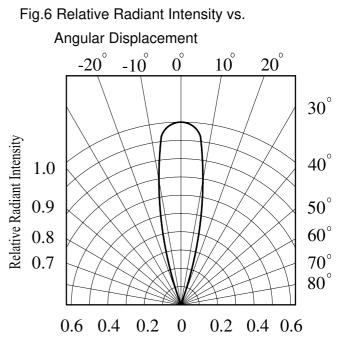
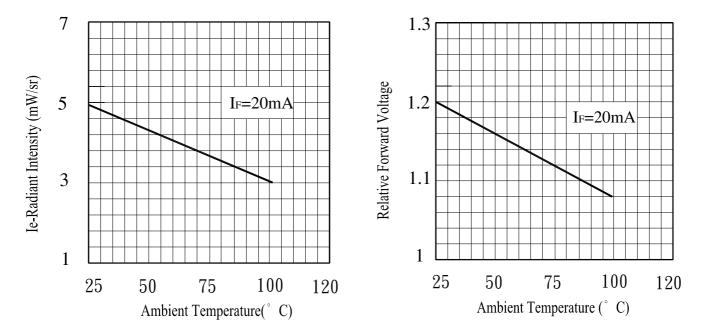


Fig.8 Forward Voltage vs. Ambient Temperature(°C)



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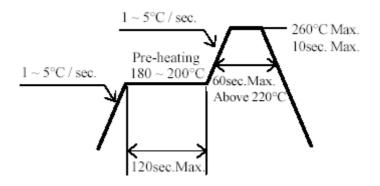


Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

http:\\www.everlight.com Prepared date : 07-19-2004



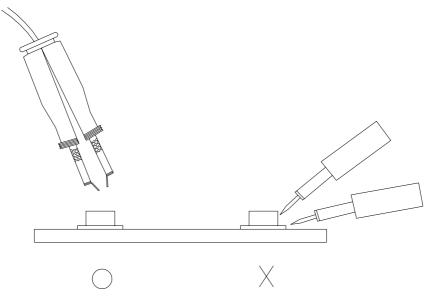
4.Soldering Iron

IR91-21C

Each terminal is to go to the tip of soldering iron temperature less than 280° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

NO.	Item	Test Conditions	Test Hours/	Sample	Failure	Ac/Re
			Cycles	Sizes	Judgement	
					Criteria	
1	REFLOW Soldering	TEMP.∶260°C±5°C	6Mins	22pcs		0/1
		5secs			$I_R \ge U \times 2$	
2	Temperature Cycle	$H:+100^{\circ}C$ 15mins	50Cycles	22pcs	$Ee \leq Lx0.8$	0/1
		5mins			$V_F \ge U x 1.2$	
		$L:-40^{\circ}C$ 15mins				
3	Thermal Shock	H :+100°C 5 mins	50Cycles	22pcs	U: Upper	0/1
		▼ 10secs			Specification	
		$L:-10^{\circ}C$ 5mins			Limit	
4	High Temperature	TEMP. ∶ +100°C	1000hrs	22pcs	L: Lower	0/1
	Storage				Specification	
5	Low Temperature	TEMP. ∶ -40°C	1000hrs	22pcs	Limit	0/1
	Storage					
6	DC Operating Life	I _F =20mA	1000hrs	22pcs]	0/1
7	High Temperature/	85℃ /85% R.H	1000hrs	22pcs		0/1
	High Humidity					



Packing Quantity Specification

1.1000PCS/1Bag ,20Bags/1Box

2.10Boxes/1Carton

Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number MADE IN TAIWAN: Production Place

Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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